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Temperature Field Analysis for ZnO Thin-Film Pyroelectric Devices with Partially Covered Electrode

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In this study, a finite element modeling is applied to simulate the temperature field of multilayer ZnO pyroelectric devices. The results show that alterations to the electrode width to improve the temperature variation rate are more successful when the ZnO film thickness is reduced. The marked improvement in the temperature variation rate in the ZnO layer of 200 nm thickness indicates a saturation rate of about 27% when the electrode width is approximately 1 μ m. Furthermore, the optimal electrode width is reduced when the ZnO film thickness is decreased. Decreasing the ZnO film thickness clearly increases the temperature variation rate and reduces the response time; an electrode with the optimal width further enhances the temperature variation rate. Moreover, the temperature variation rate significantly decreases for thinner ZnO films when the electrode width is smaller than the optimal value. In addition, an experimental result is successful to verify the simulation results, and the electrode width is a critical parameter for designing a pyroelectric sensor.

1. Introduction

ZnO is a unique material because it possesses such properties as semiconductivity, piezoelectricity, and pyroelectricity. Wide-band-gap wurtzite phase ZnO has attracted attention owing to its versatility in many promising applications, such as blue and ultraviolet light emitters, transparent conductors, solar cell windows, gas sensors, photovoltaic devices, pyroelectric sensors, surface acoustic wave (SAW) devices, and

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film bulk acoustic resonators (FBARs). Pyroelectric devices have been successfully used in many applications, such as pollution monitoring, hot image detectors, intruder alarms, and gas analysis.⁽¹⁻³⁾ Thin-film pyroelectric sensors have many advantages, such as integration with on-chip circuitry, uncooled detection, room-temperature operation, speed, lower system cost, portability, and wide spectral response with high sensitivity. In addition, pyroelectricity has been applied to environmental energy-harvesting systems. Pyroelectric energy conversion offers a novel and direct way of converting time-dependent temperature fluctuations into electricity for micropower generators and low-energy consumption systems.⁽⁴⁾

Thin-film pyroelectric sensors comprise a pyroelectric layer sandwiched between top and bottom electrodes, and built on a thermal-isolation structure to block heat loss. The top side is exposed to a heat source. The principle of thin-film pyroelectric sensors is based on the pyroelectric effect, which converts the temperature variation to the corresponding electrical signal. The dynamic pyroelectric response current of thin-film pyroelectric sensors can be described using eq. (1):

$$i_{\rm p} = \eta \times P \times A \times {\rm d}T/{\rm d}t, \tag{1}$$

where η is the absorption coefficient of radiation, P is the pyroelectric coefficient of the pyroelectric film, A is the sensing area, and dT/dt is the temperature variation rate of the pyroelectric film. The thermal-isolation structure, sensitive material properties, top-electrode layout, and absorption coefficient of pyroelectric devices are their most important performance-enhancing qualities. From eq. (1), it can be seen that a higher temperature variation rate in pyroelectric films leads to a higher response current in the pyroelectric sensors. Moreover, a partially covered top electrode has been proven to reveal a higher responsivity than a fully covered electrode because it allows the ZnO layer to make a direct contact with the heat source.⁽⁵⁾ Moreover, a web-type top electrode has been designed to enhance the responsivity of ZnO pyroelectric sensors by qualitative analysis.⁽⁶⁾ A larger piecewise area of the exposed ZnO layer leads to more heat absorption but, in another aspect, to more dispersed top electrodes. Thus, the design of the web-type top electrode can consider both the piecewise area of the exposed ZnO layer and the dispersion of top electrodes. The outer regions of the web-type possess a larger piecewise area of the exposed ZnO layer, while the inner regions possess the lower dispersion of top electrodes. Therefore, the temperature variation rate increases in pyroelectric films when the partially covered top electrode is applied in pyroelectric sensors. This concept has been further expanded to the etching of a three-dimensional pattern on the responsive element of LiTaO₃, with lateral temperature gradients induced on the sidewalls of the responsive element under homogeneous irradiation.⁽⁷⁾ Thus, the temperature variation rate increases in the responsive element which, in turn, increases the voltage responsivity of pyroelectric sensors. Moreover, the temperature variation rate is difficult to extract from thin films by experimental measurement. One study used a finite element model built using the commercial software ANSYS to explore the temperature variation rate in pyroelectric elements with various thermal properties and geometries.(8)

The pyroelectricity of ZnO is attributable to non-centrosymmetrical crystals and so it has a specific polar axis along the direction of spontaneous polarization.^(1,2) The most densely packed and thermodynamically favorable growth orientation in a ZnO wurtzite structure is one in which the c-axis is perpendicular to the substrate. ZnO films with the c-axis normal to the substrate are preferred in many applications, such as ZnO pyroelectric devices^(5,9) and film bulk acoustic resonators.⁽¹⁰⁾ When ZnO is subjected to temperature variations, its internal polarization will produce an electric field. Therefore, increasing the responsivity of a ZnO pyroelectric sensor depends on increasing the temperature variation rate of the ZnO layer, adopting a ZnO film with a strongly preferred orientation towards the c-axis, and using a high-performance thermal-isolation structure.

In this paper, our focus was on exploring the temperature variation rate in multilayer ZnO pyroelectric devices with a partially covered top electrode. The top electrode layout and size were designed and implemented, and a finite element model built using a commercial multiphysics software COMSOL MULTIPHYSICS[®] 3.5 was used to explore the temperature variation rate in multilayer ZnO pyroelectric devices.

2. Materials and Methods

2.1 Structure and fabrication of pyroelectric sensor

The present ZnO thin-film pyroelectric sensor is a sandwich structure composed of a ZnO sensing layer sandwiched between top and bottom electrodes, and built on a silicon substrate with a thermal-insulation layer to reduce heat loss. The pyroelectric signal is proportional to the temperature variation rate in the ZnO layer. In other words, a higher temperature variation rate in the ZnO layer leads to a higher response current for pyroelectric sensors. A partially covered top electrode has a higher responsivity than a fully covered top electrode because the uncovered part of the ZnO layer is directly exposed to the heat source and, thus, markedly increases the heat absorption.⁽⁵⁾ A larger top electrode area reduces the temperature variation rate in the ZnO layer; however, a larger bare top electrode area increases the temperature variation rate in the ZnO layer but decreases the responsivity of sensors owing to the smaller top electrode area to hold electrical charges. Therefore, we designed a partially covered top electrode with a mesh type. Figure 1 shows the schematic of the multilayer ZnO pyroelectric sensor with the fully covered and mesh top electrodes. The layout of the mesh top electrode had the same ratio for the widths of the electrode and bare electrode to deal with both the temperature variation rate and top electrode area. The dimensions of the top electrodes are detailed in Fig. 2. The area of the mesh top electrode was about 12.15 mm^2 when the electrode width (W) was fixed at 0.5, 1, 2, 3, 4, 5, 6, 10, and 20 μ m, and the area of the fully covered top electrode was about 14.4 mm². Moreover, W seemed to be related to the thickness of the ZnO sensing layer. W could then be optimized by exploring and analyzing the temperature variation rate in ZnO layers of varying thicknesses.

The fabrication flow of the ZnO pyroelectric device was divided into several steps, as follows. A silicon wafer with both sides polished was used as a substrate to support the multilayer ZnO pyroelectric sensors, as shown in Fig. 3(a). A Si_3N_4 layer of 1 µm



Fig. 1. Schematic of the multilayer ZnO pyroelectric sensors: (a) fully covered electrode and (b) mesh top electrode.

thickness was deposited on both sides of the silicon wafer by low-pressure chemical vapor deposition (LPCVD), as shown in Fig. 3(b). The silicon nitride layer can obstruct the thermal conduction to the silicon substrate. The bottom electrode was deposited on the substrates by electron beam evaporation and patterned by wet etching, as shown in Fig. 3(c). The bottom and top electrodes were both composed of gold and chromium. The chromium was an adhesion layer to promote the adhesion between the gold electrode and the substrate or ZnO films. The thicknesses of gold and chromium were 50 and 5 nm, respectively. The next step was to deposit ZnO films by sputtering, as shown in Fig. 3(d). A ZnO target with 99.99% purity was adopted. The ZnO target was presputtered for 15 min prior to the film deposition to remove any surface impurity. The chamber was then filled with the mixture of argon and oxygen with the gas-mixing ratio of 5:3. The chamber pressure was 2×10^{-3} Torr during deposition. The substrate was heated up to 200°C during deposition, which was beneficial for improving the ZnO film quality. The



Fig. 2. Top electrode dimensions in micrometer: (a) fully covered type and (b) mesh type.

sputtering RF power significantly affects the ZnO film quality, and therefore, affects the responsivity of ZnO pyroelectric sensors. A two-step sputtering process, with a lower RF power of 120 W followed by a higher RF power of 150 W, was used to achieve a better responsivity of pyroelectric sensors.⁽⁹⁾ The first-step RF power was used to deposit one-tenth of the required total ZnO film thickness when using the two-step sputtering process. The processing step in Fig. 3(e) was used to deposit the top electrode on the ZnO layer. The composition and deposition of the top electrode were similar to those of the bottom electrode, except that the top electrode was patterned by the lift-off method. Finally, as shown in Fig. 3(f), the wet etchant comprising CH₃COOH:H₃PO₄:H₂O = 1:1:10 was used to pattern the ZnO layer to open the bonding pad of the bottom electrode.

2.2 *Finite element model and simulation*

Temperature variation rates in the pyroelectric layers markedly affect the responsivity of pyroelectric sensors. A partially covered electrode has better output signals than a fully covered electrode.⁽⁵⁾ Increasing the temperature variation rate or the top electrode area can improve the electrical signals of pyroelectric devices. Therefore, a partially covered mesh-type electrode was used in the ZnO pyroelectric devices to maximize both



Fig. 3. Process flow of multilayer ZnO pyroelectric sensor with mesh-type top electrode: (a) using silicon wafer as the substrate, (b) depositing Si_3N_4 layers on both sides of the substrate by LPCVD, (c) depositing the bottom electrode by electron beam evaporation and wet etching the pattern, (d) depositing ZnO layer by RF magnetron sputtering, (e) depositing top electrode by electron beam evaporation and patterning by lift-off, and (f) patterning the ZnO layer by wet etching to open the bonding pad of the bottom electrode.

the temperature variation rate and the top electrode area. However, the optimal W in the mesh top electrode seemed to be related to the thickness of the ZnO sensing layer. In the present study, a two-dimensional finite element model was generated using a commercial multiphysics software COMSOL MULTIPHYSICS[®] 3.5 to explore the temperature variation rate in the multilayer ZnO pyroelectric sensors with a mesh top electrode as compared with a fully covered top electrode. The optimal W in the mesh top electrode was determined under various ZnO thicknesses by exploring the temperature variation rate in the ZnO sensing layer. The material parameters of the films and substrate

are shown in Table 1. There was an isotropic assumption for the films and substrate properties in this model. The model was meshed using a regular mesh, as shown in Fig. 4. The thicknesses of the ZnO layers were 200, 600, and 1200 nm. W in the mesh top electrode varied from 0.5, 1, 2, 3, 4, 5, 6, 10 to 20 μ m. The incident irradiation power applied on the top side of the multilayer ZnO pyroelectric devices was approximately $1.228 \times 10^{-12} \text{ W/}\mu\text{m}^{2.(8)}$ The thermal isolation condition was applied to the backside of the silicon substrate, and the symmetric condition was applied to the two lateral sides as boundary conditions.

Table 1

Material parameters used	for finite element analysis.
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Material	Thermal conductivity (Wm ⁻¹ K ⁻¹)	Specific heat (Jg ⁻¹ K ⁻¹)	Density (gcm ⁻³)	Thickness (µm)
Silicon substrate	163	0.703	2.33	5
Silicon nitride	20	0.700	3.10	1
Top and bottom electrodes	317	0.129	19.3	0.1
Zinc oxide	6	0.125	5.676	0.2, 0.6, 1.2





Fig. 4. Two-dimensional finite element model for ZnO thin-film pyroelectric devices: (a) fully covered electrode and (b) mesh top electrode.

2.3 Signal measurement

A responsivity measurement system (Fig. 5) was used to evaluate the performance of the present ZnO pyroelectric sensors. The radiation source was a calibrated infrared (IR) laser of 900 nm wavelength and 7 mW maximum power. The power spectrum of the laser was also measured using a power meter by Fourier transform infrared (FTIR) spectroscopy. The laser beam was chopped and molded as a square wave with a modulated frequency (ω) by a programmable function generator. The modulated beam was split into two beams by a prism. The two beams had the same power, one was reflected on a photodiode as the reference, and the other was expanded via a beam expander such that the beam spot could cover the entire region of the patterned top electrode of the ZnO pyroelectric sensors. The photodiode was used simply for visual reference on the oscilloscope. The output voltage of the sensor was amplified using an SR560 low-noise voltage amplifier. Both the output signals of the sensors and the photodiode were recorded and displayed using a digital oscilloscope.

3. Results and Discussion

When ZnO is subjected to temperature variation, its internal polarization produces an electrical field that induces voltage responsivity between the top and bottom electrodes. The responsivity is proportional to the temperature variation rate in the ZnO layer: no



Fig. 5. Schematic diagram of the responsivity measurement experiment.

428

temperature variation in the ZnO layer results in no internal polarization change, and thus, no response voltage. Therefore, the transient temperature fields in multilayer ZnO pyroelectric sensors were simulated. The points are defined in Fig. 6 and used to explain the temperature variation rate in the ZnO pyroelectric devices with a mesh top electrode compared with a fully covered top electrode. The points A1, B1, C1, D1, E1, and F1 were defined at the top of the ZnO layer. The points A3, B3, C3, D3, E3, and F3 were defined at the middle of the ZnO layer. The points A5, B5, C5, D5, E5, and F5 were defined at the bottom of the ZnO layer. In the mesh top electrode, the temperature variation rates at the points under the electrodes were only useful to produce the electrical charges.

Figure 7 shows the relationship between the temperature variation rate and time in the ZnO film along the thickness direction from points A1 to A5, while the fully covered top electrode with a 200-nm-thick ZnO layer was used to fabricate the ZnO pyroelectric sensor. When the point approached the top side of the ZnO layer, the temperature variation rate further increased, and its maximum peak moved leftward, reducing the response time. Hence, point A5 had the lowest temperature variation rate in the ZnO layer under the design of the fully covered top electrode. When a mesh top



(b)

Silicon substrate

Fig. 6. Points defined in ZnO layers: (a) fully covered electrode and (b) mesh top electrode.



Fig. 7. Relationship between temperature variation rate (dT/dt) and time in ZnO film along the thickness direction in a fully covered electrode with a 200-nm-thick ZnO layer.

electrode with W of 5 µm and a 200-nm-thick ZnO layer was used to fabricate the ZnO pyroelectric sensor, point F1 showed direct contact with the irradiation source. The temperature variation rate at point F1 was clearly higher than at points A1, B1, C1, D1, or E1, as shown in Fig. 8. Moreover, the temperature variation rate at point E1 was higher than at points B1, C1 or D1 because point E1 approached the uncovered top electrode directly to contact the heat source. The temperature variation rate at point E5 was also higher than that at points D5, C5 or B5, as shown in Fig. 9. Therefore, as the point started from the center of the mesh top electrode projected to the ZnO layer (points B1, B2, B3, B4, or B5) and moved to the edge of the mesh top electrode projected to the ZnO layer (points E1, E2, E3, E4, or E5), the temperature variation rate further increased and its maximum peak moved leftward. Figure 10 shows the relationship between the temperature variation rate and time in the ZnO film from points B1 to B5, with the temperature variation rate further increasing and its maximum peak moving leftward when the point approached the top side of the ZnO layer. Hence, point B5 had the lowest temperature variation rate in the ZnO layer under the design of the mesh top electrode. Points at the top side of the ZnO layer had the largest temperature variation rate, which could hardly be improved. However, improvement in the temperature variation rate at point B5, which possessed the lowest temperature variation rate, certainly enhanced the responsivity of the pyroelectric devices. Figure 11(a) shows the transient temperature variation field at the maximum peak's time of point A5 when the fully covered top electrode with a 200-nm-thick ZnO layer was used to fabricate the ZnO pyroelectric sensor. The temperature variation rate in the ZnO film increased gradually toward the top electrode owing to the incident radiation power applied on the top electrode. Figure



Fig. 8. Relationship between temperature variation rate (dT/dt) and time in ZnO film at points A1 to F1: a mesh top electrode with a 5 µm electrode width and a 200-nm-thick ZnO layer compared with a fully covered top electrode with a 200-nm-thick ZnO layer.



Fig. 9. Relationship between temperature variation rate (dT/dt) and time in ZnO film at points B5 to F5 for a mesh top electrode with a 5 μ m electrode width and a 200-nm-thick ZnO layer.



Fig. 10. Relationship between temperature variation rate and time in ZnO film from points B1 to B5 for a mesh top electrode with a 5 μ m electrode width and a 200-nm-thick ZnO layer.



Fig. 11. Transient temperature variation field in multilayer ZnO pyroelectric devices: (a) fully covered electrode and (b) mesh top electrode.

11(b) shows the transient temperature variation field at the maximum peak's time of point B5 when the mesh top electrode with W of 1 μ m and a 200-nm-thick ZnO layer was used to fabricate the ZnO pyroelectric sensor. The temperature variation rate in the ZnO film clearly increased, which was attributed to the bare top electrode permitting the incident radiation power to directly contact the ZnO film. Therefore, the mesh top electrode was effective in enhancing the temperature variation rate in pyroelectric films.

When considering the 200-nm-thick ZnO layer used to fabricate the ZnO pyroelectric devices, Fig. 12 shows the relative change in the maximum peak value of the temperature variation rate at points B5, C5, D5, and E5 in the mesh top electrode compared with that at point A5 in the fully covered electrode under various electrode width sizes. Namely, the relative change in dT/dt can be expressed as

Relative change in
$$dT/dt$$
 (%) = $[(dT/dt)_{\rm m} - (dT/dt)_{\rm f}] / (dT/dt)_{\rm f} \times 100\%$, (2)

where $(dT/dt)_m$ is the maximum peak value of the temperature variation rate at points B5, C5, D5, and E5 in the mesh top electrode, and $(dT/dt)_f$ is the maximum peak value of the temperature variation rate at point A5 in the fully covered electrode. When *W* was



Fig. 12. Relative change in maximum peak value of temperature variation rate at points B5 to E5 in the mesh top electrode compared with that at point A5 in the fully covered electrode for a 200-nm-thick ZnO layer used with various electrode widths.

larger than 10 μ m, the maximum peak value of the temperature variation rate was no different between the mesh top electrode at points B5, C5, and D5 and the fully covered electrode at point A5, with the exception of point E5 as its point approached the bare top electrode. Therefore, attempts to improve the temperature variation rate of ZnO layers and responsivity of pyroelectric devices using a mesh top electrode with *W* larger than 10 μ m were unsuccessful. Namely, a larger electrode width size induced the ZnO layer under the mesh top electrode having a lower lateral temperature gradient to absorb heat irradiation from the bare top electrode. Furthermore, the relative change in the maximum peak value of the temperature variation rate at points B5, C5, D5 and E5 in the mesh top electrode for the 200-nm-thick ZnO film. However, when *W* was decreased to 0.5 μ m, the temperature variation rate declined by about 12.5% from that of the optimal *W* of 1 μ m because the reduction in the bare top electrode area induced less incident radiation energy to be absorbed in the ZnO layer.

By increasing the thickness of the ZnO layer to about 600 nm, the relative change in the maximum peak value of the temperature variation rate at points B5, C5, D5, and E5 in the mesh top electrode compared with that at point A5 in the fully covered electrode was about 17.5% when *W* was about 2 µm, as shown in Fig. 13. Hence, *W* of 2 µm was



Fig. 13. Relative change in maximum peak value of temperature variation rate at points B5 to E5 in the mesh top electrode compared with that at point A5 in the fully covered electrode for a 600-nm-thick ZnO layer used with various electrode widths.

the optimum when designing the mesh top electrode for the 600-nm-thick ZnO film. However, decreasing W to 0.5 µm induced a decrease in the temperature variation rate of about 5.7% compared with that of the optimal W of 2 µm. With the thicker ZnO layer of about 1200 nm, the relative change in the maximum peak value of the temperature variation rate at points B5, C5, D5, and E5 in the mesh top electrode compared with that at point A5 in the fully covered electrode was saturated at about 12.5% when the W was about 3 µm, as shown in Fig. 14. Hence, W of 3 µm was the optimum when designing the mesh top electrode for the 1200-nm-thick ZnO film. However, decreasing W to 0.5 µm induced a decrease in the temperature variation rate of about 1.9% from that of the optimal W of 3 µm. Hence, the effects of altering W to improve the temperature variation rate were more evident with decreases in the ZnO film thickness. The temperature variation rate significantly declined for thinner ZnO films when W was smaller than the optimal W.

Figure 15 shows the relationship between the temperature variation rate and time at point B5 under various ZnO film thicknesses and *W*s. The temperature variation rate improved by about 28.5% when *W* of 20 μ m was reduced to 1 μ m (saturation point) when using the 200-nm-thick ZnO film. The temperature variation rate improved by about 16.3% when *W* of 20 μ m was reduced to 2 μ m (saturation point) when using the



Fig. 14. Relative change in maximum peak value of temperature variation rate at points B5 to E5 in the mesh top electrode compared with that at point A5 in the fully covered electrode for a 1200-nm-thick ZnO layer used with various electrode widths.



Fig. 15. Relationship between temperature variation rate (dT/dt) and time at point B5 under various ZnO film thicknesses and electrode widths.

600-nm-thick ZnO film. The temperature variation rate improved by about 10% when W of 20 µm was reduced to 3 µm (saturation point) when using the 1200-nm-thick ZnO film. Improvements to the temperature variation rate by altering W were reduced when a thicker ZnO film was adopted. The reason for the lack of improvement in the temperature variation rate was attributed to the thicker ZnO layers possessing a higher heat capacity. Hence, decreasing the ZnO film thickness could clearly increase the temperature variation rate and reduce the response time; then, the optimal W, which would further enhance the temperature variation rate, could be determined by exploring the temperature variation rate in ZnO layers with various thicknesses.

A transient temperature field with a chopping frequency was simulated when the multilayer ZnO pyroelectric devices were exposed to irradiation power with a chopping periodic time. A square waveform was produced using a programmable function generator to modulate the irradiation power with a chopping periodic time of about 2×10^{-6} s,

as shown in Fig. 16. Figure 17 shows the temperature variation rate of the ZnO layer in the mesh top electrode with the optimal W at point B5, compared with that in the fully covered electrode at point A5 under various ZnO film thicknesses when the incident irradiation power was modulated with a chopping frequency of about 0.5 MHz. The temperature variation rate in the 200-nm-thick ZnO film was clearly larger than those in the films of 600 and 1200 nm thicknesses. Altering W to improve the temperature variation rate had a clearer effect for thinner pyroelectric films.

An experimental setup was used to verify the above analytical results. The voltage responsivity is proportional to the temperature variation rate in the ZnO layer. Therefore, the IR laser beam was chopped and molded as a square wave with a modulated frequency to obtain a temperature variation in the ZnO layer by a programmable function generator. In the present study, a two-step sputtering process was used to deposit a 1.2-µm-thick ZnO film. Figure 18 shows the X-ray diffraction pattern for the ZnO film deposited by the proposed two-step sputtering, which was observed to possess the growth characteristic of strongly preferred orientation toward the c-axis. The fabricated ZnO pyroelectric sensors with $W_{\rm S}$ of 30, 100, and 500 μ m are shown in Fig. 19. Figure 20 shows the voltage responsivities (Rv) of the present ZnO pyroelectric sensors with Ws of 30, 100, and 500 μ m. Rv is defined as the ratio of the output voltage of the sensor to the input power of the incident heat source. At identical total top electrode areas about 12.15 mm² for the present ZnO pyroelectric sensors with Ws of 30, 100, and 500 μ m, the ZnO pyroelectric sensor with W of 30 µm had a larger voltage responsivity of about 4.519 V/W at the frequency of 100 Hz than that with W of 100 μ m (about 4.281 V/W) and 500 µm (about 3.628 V/W). Moreover, the difference in the voltage responsivity among various Ws decreased when increasing frequency. A larger W was helpless to promote the temperature variation rate and the voltage responsivity. Therefore, these experimental results were sufficient to verify the simulation results, and W was a critical parameter for designing a pyroelectric sensor.



Fig. 16. Square waveform used to modulate the irradiation power using a programmable function generator.



Fig. 17. Temperature variation rate of ZnO layer in the mesh top electrode with the optimal electrode width at point B5 compared with that in the fully covered electrode (FCE) at point A5 for various ZnO film thicknesses upon the incident irradiation power modulated with a chopping frequency of about 0.5 MHz.



Fig. 18. XRD pattern of the ZnO film deposited by the two-step sputtering process.



Fig. 19. The fabricated ZnO pyroelectric sensors with various Ws: (a) 30, (b) 100, and (c) 500 μ m.



Fig. 20. Voltage responsivities (Rv) of the ZnO pyroelectric sensors with various Ws.

4. Conclusions

A finite element model is used to explore the temperature variation rate in multilayer ZnO pyroelectric sensors with the mesh top electrode compared with the fully covered top electrode. The partially covered top electrode was remarkable in improving the responsivity of pyroelectric devices. An optimal W was obtained by exploring the temperature variation rate in ZnO layers of various thicknesses. Decreasing the ZnO film thickness was beneficial in improving the temperature variation rate and optimal W, as determined, and further enhanced the temperature variation rate. Improvements in the temperature variation rate by altering W were more obvious when the ZnO film thickness was reduced. Moreover, the temperature variation rate significantly declined for thinner ZnO films when W was smaller than the optimal value. In addition, an experimental result was successful to verify the simulation results, and W was a critical parameter for designing a pyroelectric sensor.

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